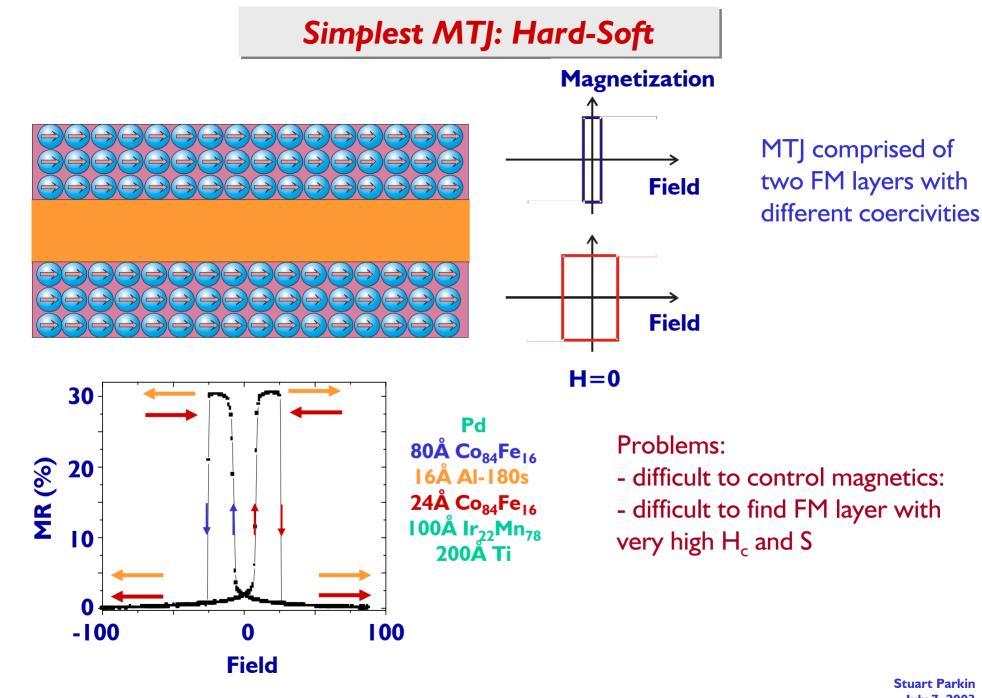
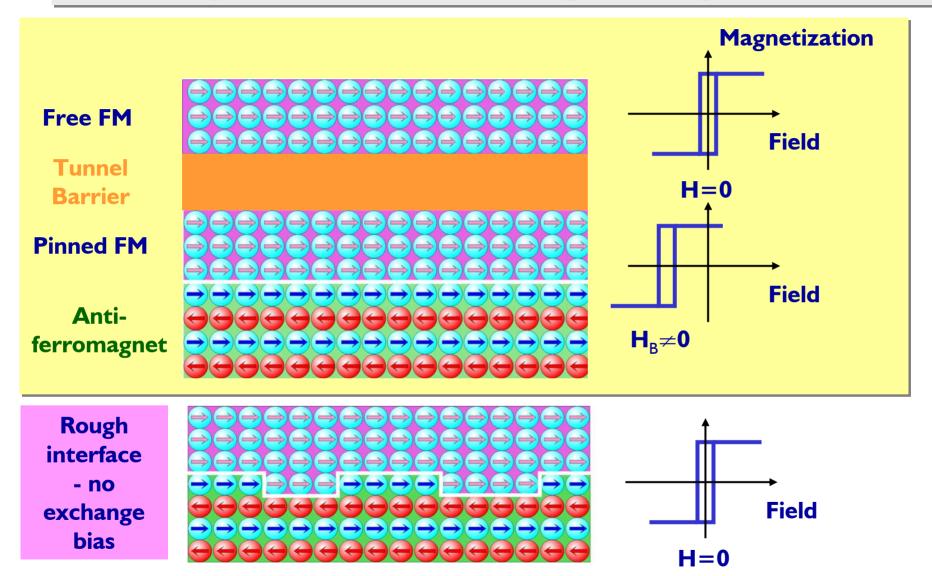
## **Magnetic Tunneling Junctions: History**

1974 Slonczewski - concept proposed 1975 Juliere - first demonstration (CNR-France) Fe/Ge/Co, ∆R/R~14% at 4.2 K 1982 Maekawa and Gafvert (IBM post-docs) Ni/NiO/Ni, Fe, Co, ∆R/R~0.4-2% at 4.2 K 1990~1993 Miyazaki et al. (Tohoku University) NiFe/Al-Al<sub>2</sub>O<sub>3</sub>/Co,  $\Delta$ R/R~2.7% at room temperature (RT) 1995 Miyazaki et al. (Tohoku University) - first large MR at RT Fe/Al-Al<sub>2</sub>O<sub>3</sub>/Co,  $\Delta$ R/R~18% at RT 1995 Moodera et al. (MIT) - large RT MR Co-Fe/Al-Al<sub>2</sub>O<sub>3</sub>/Co,  $\Delta$ R/R~10% at RT 1995 Gallagher and Parkin – proposal for MRAM using MTJs 1996 Parkin et al. - large RT MR >25% in shadow masked and patterned junctions; reproducible 1998 Parkin et al. - extraordinarily large RT MR; high thermal stability >35% in sub-micron junctions; >47% in shadow masked junctions specific resistances ~60 to >10<sup>9</sup>  $\Omega(\mu m)^2$ ; thermal stability (>300 °C) 1999-2000 Scheuerlein et al. – First MTJ MRAM demonstration <3 ns read and write 2001-2003 Parkin et al. – giant MR using novel tunnel barrier (>220% at RT) 2002 Durlam et al. – 1 Mbit MRAM in 0.6 µm technology 2003 Sitaram et al.; Bette et al. – 128 kbit MRAM core in 0.18 μm technology

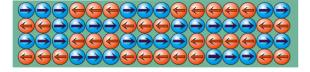




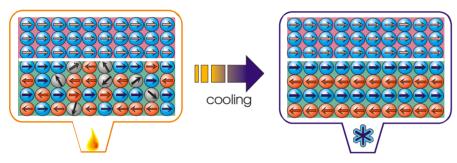
## Spin Valve Structure using Exchange Bias



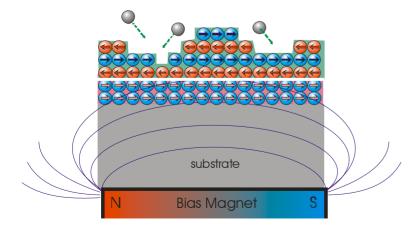
An antiferromagnet grown in the absense of a magnetic field has no long-range magnetic order



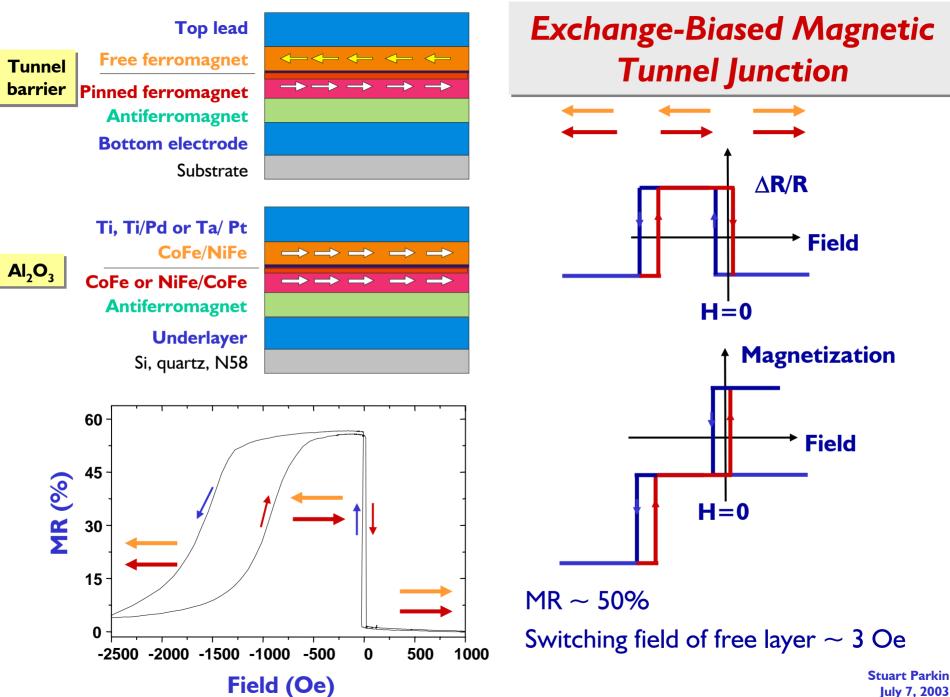
A disordered antiferromagnet layer adjacent to a ferromagnetic layer may be magnetically ordered by heating above its blocking temperature and subsequently cooling



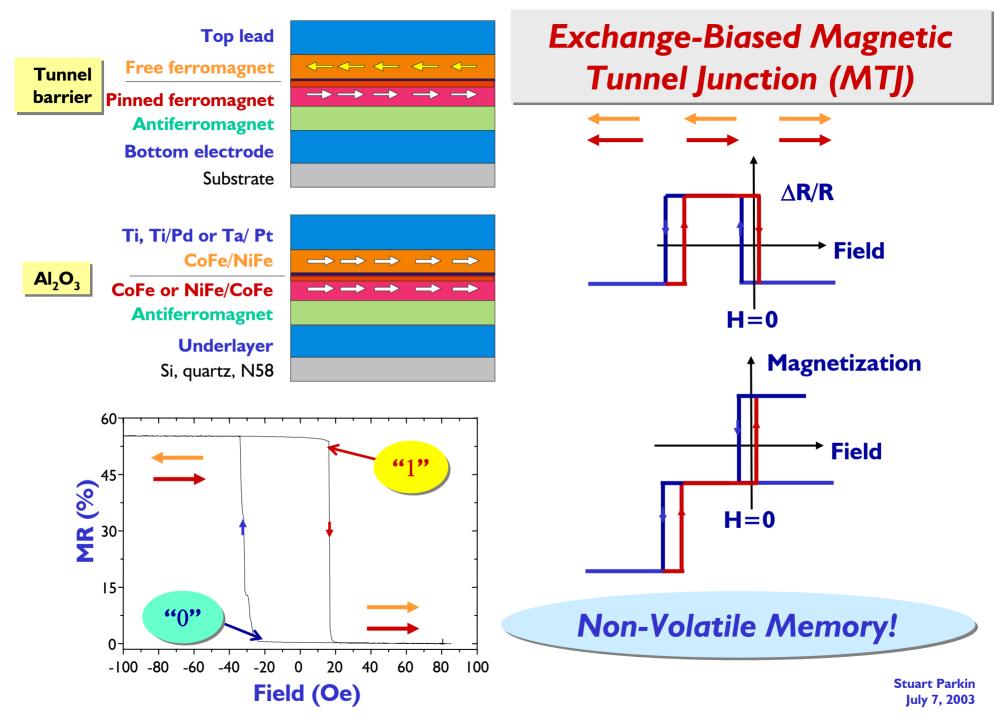
Antiferromagnet film deposition onto a ferromagnetic layer biased by an external applied field will yield a uniformly antiferromagnetically ordered layer



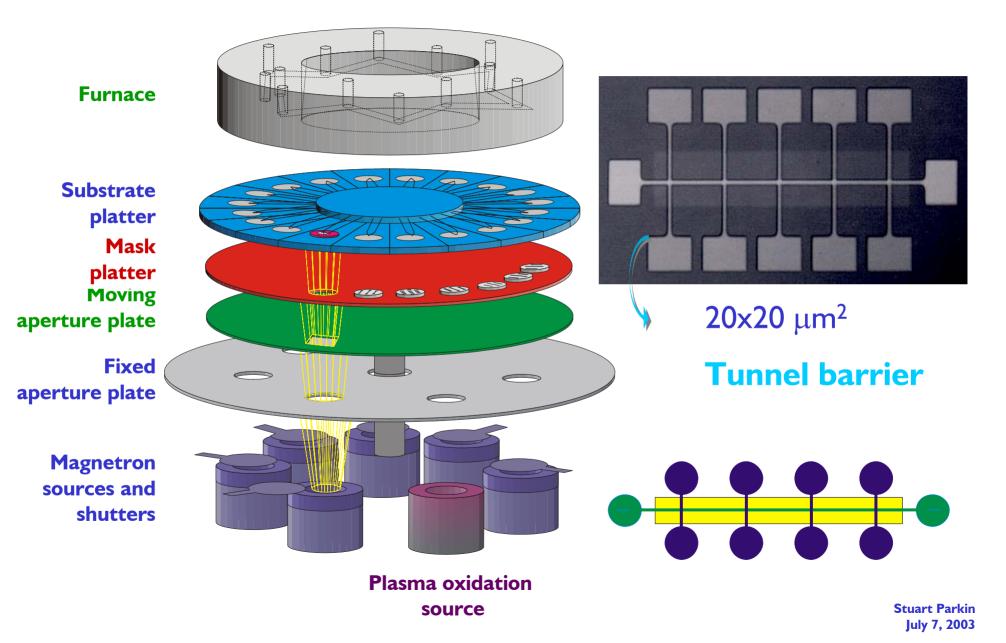
# Establishing Exchange Bias



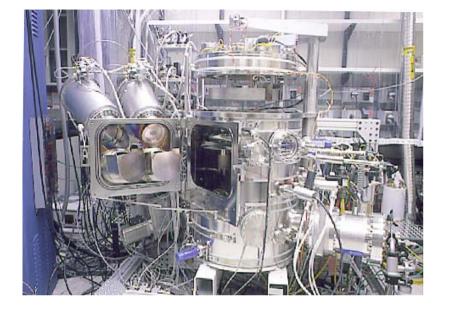
July 7, 2003



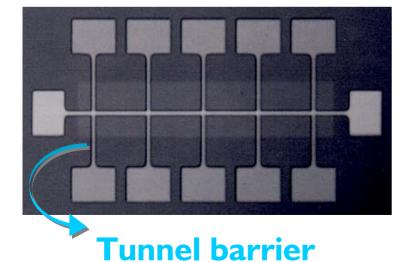
## Shadow-Masked Structures Prepared by Sputter Deposition



## Shadow-masked MTJs prepared by sputter deposition







**20x20** μm<sup>2</sup>

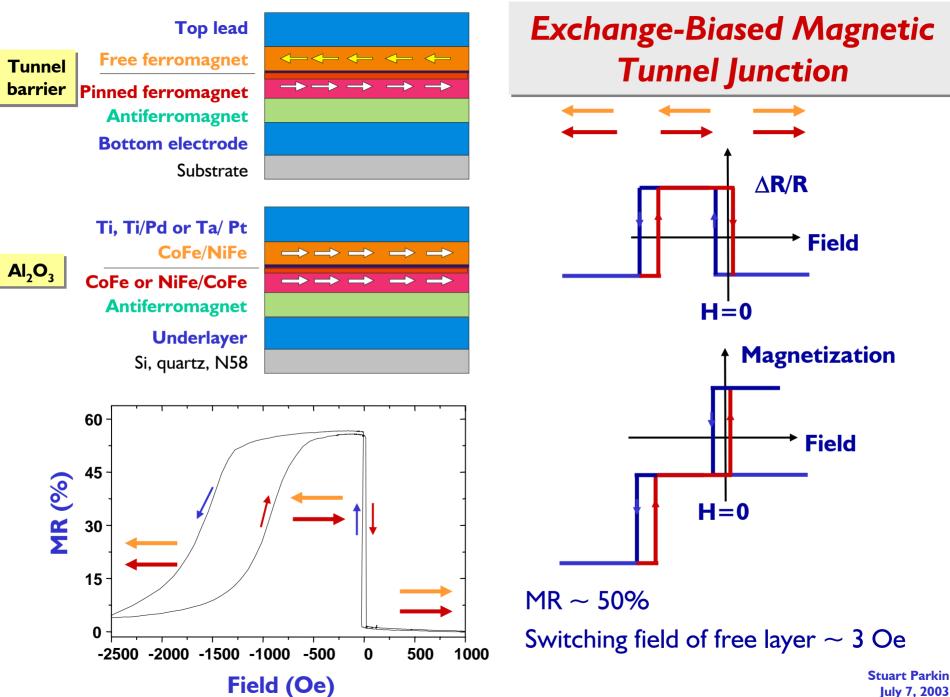
## **Lecture II: Magnetic Tunnel Junctions and MRAM**

#### **Stuart Parkin**

IBM Almaden Research Center, San Jose, California

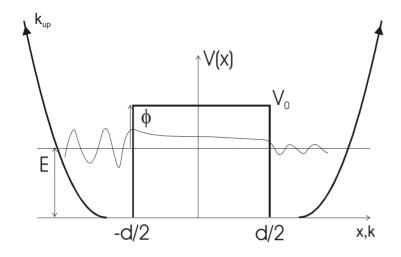
- Magnetic tunnel junctions
  - Magnetic engineering
- Spin polarization of tunneling current
  - $\sim -50\%$  for 3d transition metal ferromagnets/ Al<sub>2</sub>O<sub>3</sub>
- Magnetic Random Access Memory
  - Attractive: Non-volatile, dense and high-speed
- Magnetic Tunnel Transistor [Lecture 3]
  - Hot electron spin injection into GaAs and Si
  - 3,500% change in collector current  $\rightarrow \sim 100\%$  spin polarized current
  - Optical detection of spin polarized current using QW light emitting diode

#### Supported in part by the United States Defense Advanced Research Project Agency (DARPA)



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#### **Exact Free Electron Model of Tunneling**



Schrödinger equation

$$\frac{-\hbar^2}{2m}\frac{d^2\psi(x)}{dx^2} + \mathbf{V}(\mathbf{x})\cdot\psi(x) = E\cdot\psi(x)$$

$$k = \sqrt{\frac{2mE}{\hbar^2}} \qquad \kappa = \sqrt{\frac{2m(V_0 - E)}{\hbar^2}}$$

 $\psi(x) = e^{ikx} + R \cdot e^{-ikx} \qquad \psi(x) = A \cdot e^{-\kappa x} + B \cdot e^{\kappa x} \qquad \psi(x) = T \cdot e^{-ikx}$ 

#### Flux transmission given by:

$$\left|T\right|^{2} = \frac{\left(2k\kappa\right)^{2}}{\left(k^{2} + \kappa^{2}\right)^{2}\sinh^{2} 2\kappa d + \left(2k\kappa\right)^{2}}$$

## **Tunneling Matrix elements**

